- **Complementary Outputs**
- **Direct Overriding Load (Data) Inputs**
- **Gated Clock Inputs**
- **Parallel-to-Serial Data Conversion**
- **Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**
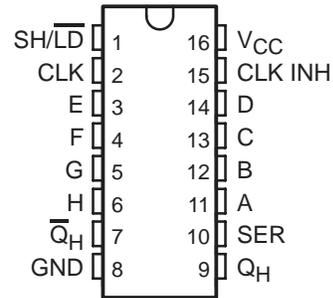
SN54ALS165 . . . J PACKAGE
SN74ALS165 . . . D OR N PACKAGE
(TOP VIEW)

SH/$\overline{\text{LD}}$	1	16	V$_{CC}$
CLK	2	15	CLK INH
E	3	14	D
F	4	13	C
G	5	12	B
H	6	11	A
$\overline{Q}_H$	7	10	SER
GND	8	9	Q$_H$

SN54ALS165 . . . FK PACKAGE
(TOP VIEW)

NC – No internal connection

description

The ′ALS165 are parallel-load 8-bit serial shift registers that, when clocked, shift the data toward serial (Q$_H$ and $\overline{Q}_H$) outputs. Parallel-in access to each stage is provided by eight individual direct data (A–H) inputs that are enabled by a low level at the shift/load (SH/$\overline{\text{LD}}$) input. The ′ALS165 have a clock-inhibit function and complemented serial outputs.
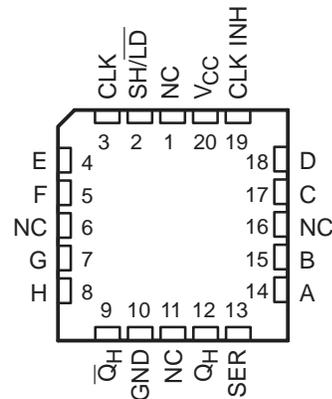
Clocking is accomplished by a low-to-high transition of the clock (CLK) input while SH/$\overline{\text{LD}}$ is held high and the clock inhibit (CLK INH) input is held low. The functions of CLK and CLK INH are interchangeable. Since a low CLK and a low-to-high transition of CLK INH also accomplishes clocking, CLK INH should be changed to the high level only while CLK is high. Parallel loading is inhibited when SH/$\overline{\text{LD}}$ is held high. The parallel inputs to the register are enabled while SH/$\overline{\text{LD}}$ is low independently of the levels of the CLK, CLK INH, or serial (SER) inputs.

The SN54ALS165 is characterized for operation over the full military temperature range of −55°C to 125°C. The SN74ALS165 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

INPUTS			FUNCTION
SH/$\overline{\text{LD}}$	CLK	CLK INH	
L	X	X	Parallel load
H	H	X	No change
H	X	H	No change
H	L	↑	Shift[†]
H	↑	L	Shift[†]

[†] Shift = content of each internal register shifts toward serial outputs. Data at SER is shifted into first register.

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TEXAS INSTRUMENTS

SN54ALS165, SN74ALS165
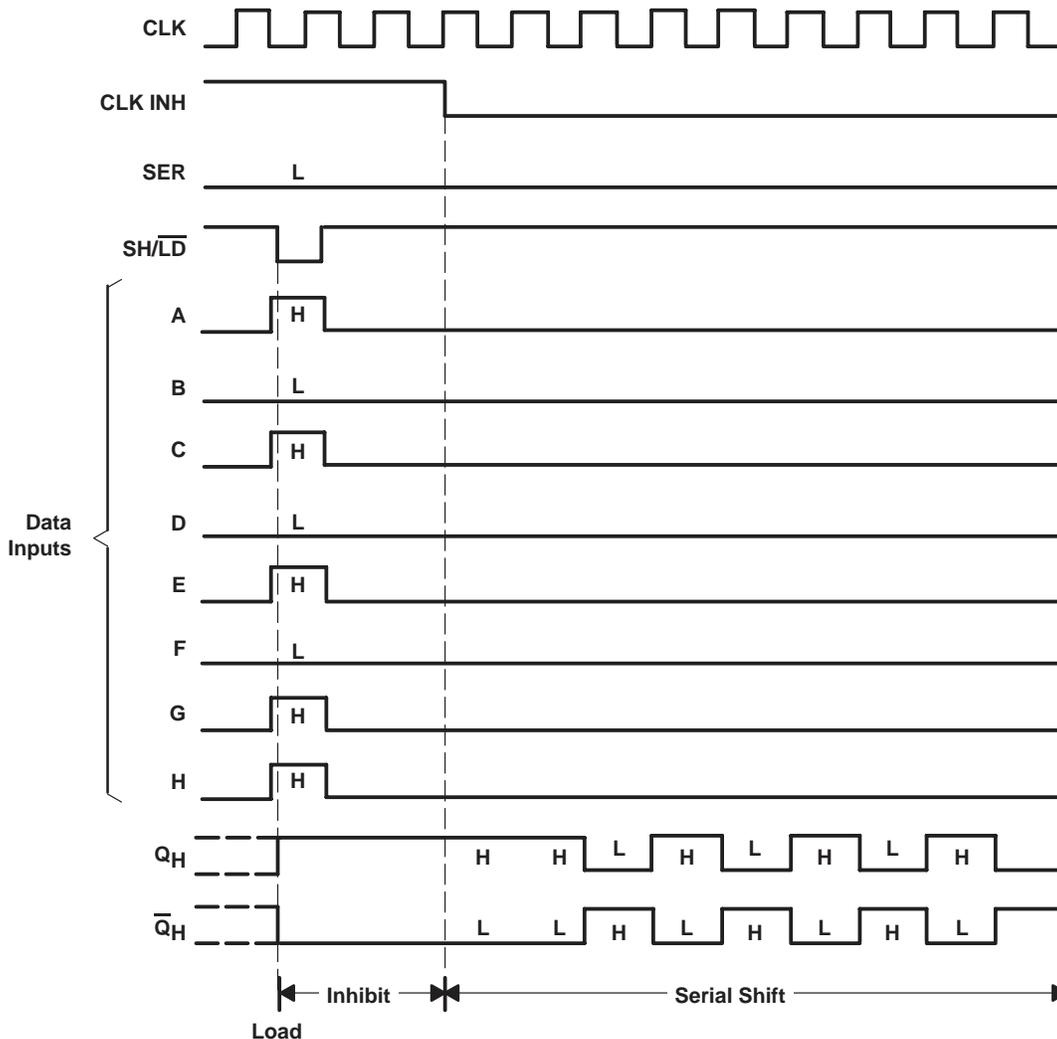# PARALLEL-LOAD 8-BIT REGISTERS
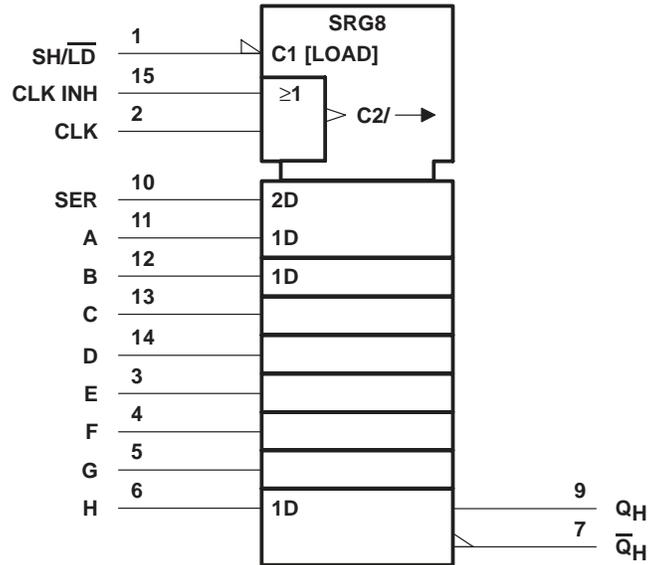
logic symbol†

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)
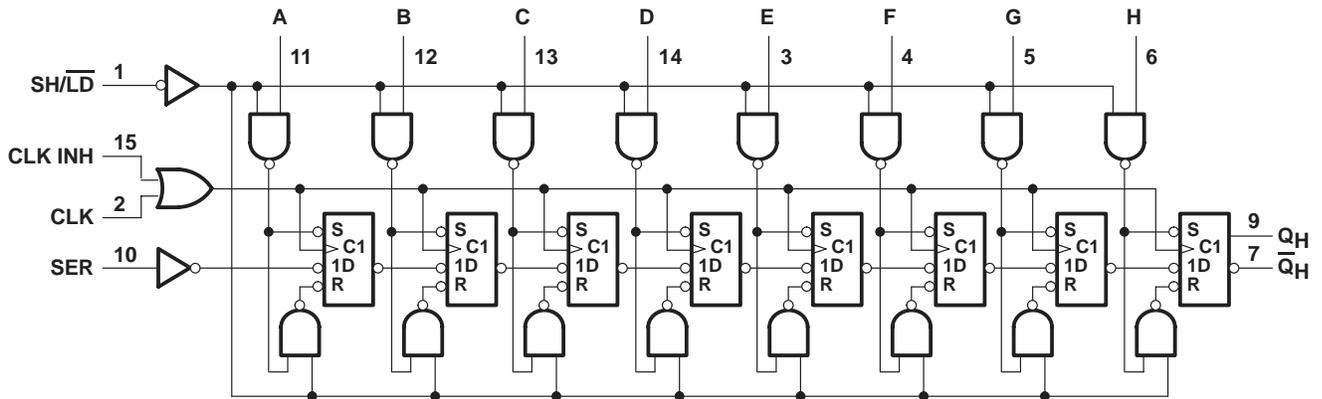
Pin numbers shown are for the D, J, and N packages.

typical shift, load, and inhibit sequences

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . 7 V
Input voltage, V_I . . . . 7 V
Operating free-air temperature range, T_A: SN54ALS165 . . . . −55°C to 125°C
SN74ALS165 . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

TEXAS
INSTRUMENTS

SN54ALS165, SN74ALS165
PARALLEL-LOAD 8-BIT REGISTERS

recommended operating conditions

			SN54ALS165			SN74ALS165			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		35	0		45	MHz
$t_{w(CLK)}$	Pulse duration, CLK (see Figure 1)	CLK high	14			11			ns
		CLK low	14			11			
$t_{w(load)}$	Pulse duration, SH/$\overline{LD}$ low	CLK low	15			12			ns
t_{su1}	Setup time, clock enable (see Figure 1)		15			11			ns
t_{su2}	Setup time, parallel input (see Figure 1)		11			10			ns
t_{su3}	Setup time, serial input (see Figure 2)		11			10			ns
t_{su4}	Setup time, shift (see Figure 2)		15			10			ns
t_h	Hold time at any input		4			4			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS165			SN74ALS165			UNIT
			MIN	TYP[†]	MAX	MIN	TYP[†]	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = − 18 mA			−1.5			−1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −0.4 mA	V_{CC} −2			V_{CC} −2			V
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	μA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.1			−0.1	mA
I_O[‡]	V_{CC} = 5.5 V,	V_O = 2.25 V	−20		−112	−30		−112	mA
I_{CC}	V_{CC} = 5.5 V,	See Note 1		12	24		12	24	mA

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.
[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.
NOTE 1: With the outputs open, CLK INH and CLK at 4.5 V, and a clock pulse applied to SH/$\overline{LD}$, I_{CC} is measured first with the parallel inputs at 4.5 V, then with the parallel inputs grounded.

switching characteristics (see Figures 1, 2, and 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX†				UNIT
			SN54ALS165		SN74ALS165		
			MIN	MAX	MIN	MAX	
f_{max}			35		45		MHz
t_{PLH}	SH/$\overline{LD}$	Any	4	23	4	20	ns
t_{PHL}			4	23	4	22	
t_{PLH}	CLK	Any	3	14	3	13	ns
t_{PHL}			3	15	3	14	
t_{PLH}	H	Q_H	3	14	3	13	ns
t_{PHL}			3	18	3	16	
t_{PLH}	H	$\overline{Q}_H$	2	17	2	15	ns
t_{PHL}			3	17	3	16	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION
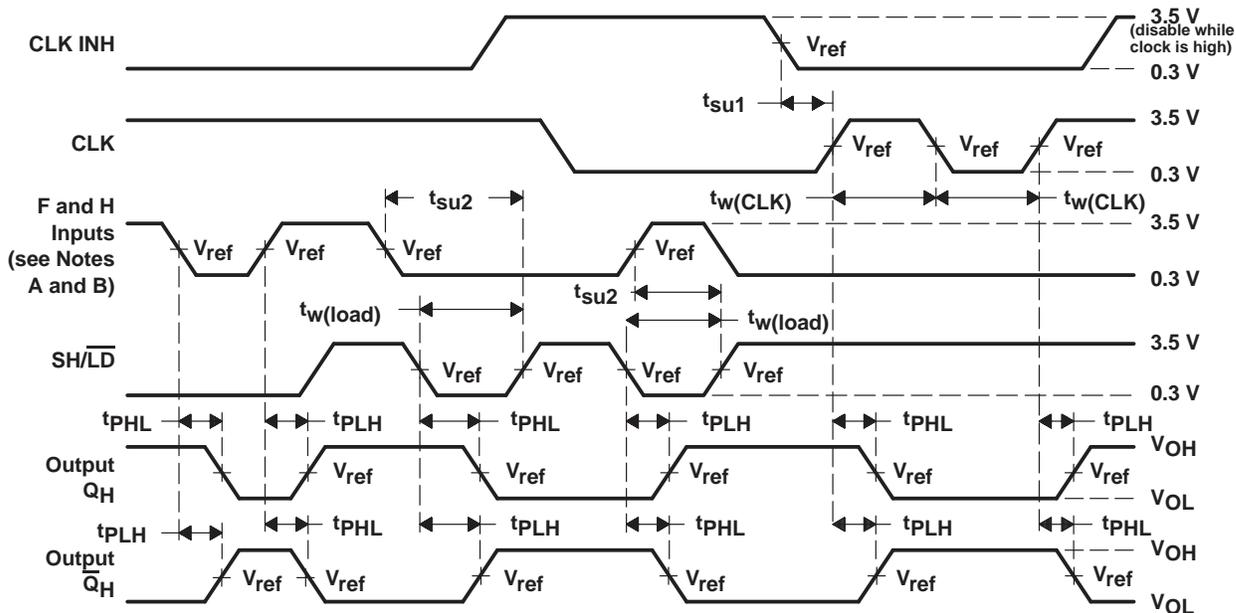
NOTES: A. The remaining six data inputs and SER are low.
B. Prior to test, high-level data is loaded into the H input.
C. The input pulse generators have the following characteristics: PRR ≤ 1 MHz, duty cycle ≤ 50%, $t_r = t_f = 2$ ns.
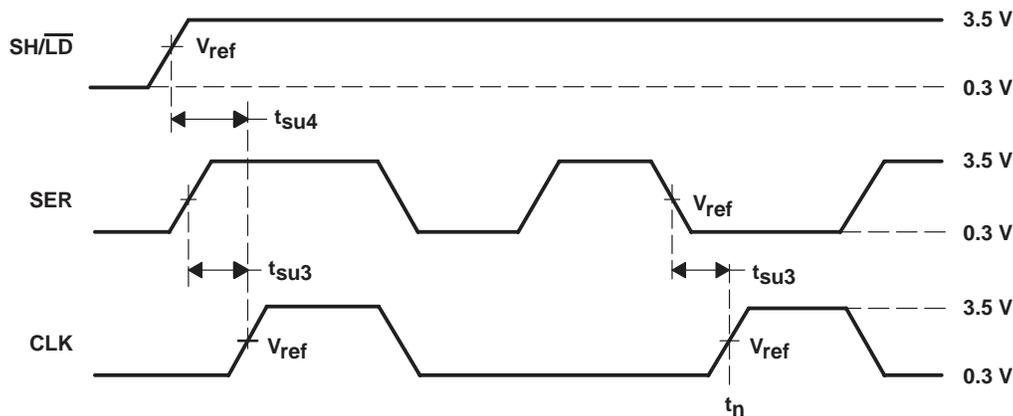D. V_{ref} = 1.3 V

Figure 1. Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

NOTES: A. The eight data inputs and CLK INH are low. Results are monitored at Q_H at $t_{n + 7}$.
B. The input pulse generators have the following characteristics: PRR ≤ 1 MHz, duty cycle = 50%, $t_r = t_f = 2$ ns.
C. $V_{ref} = 1.3$ V

Figure 2. Voltage Waveforms
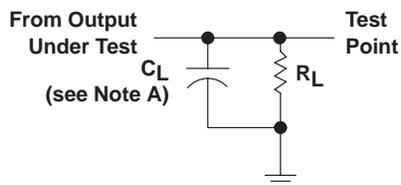
NOTE A: C_L includes probe and jig capacitance.

Figure 3. Load Circuit for Switching Tests

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS165D	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS165	
SN74ALS165DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS165	Samples
SN74ALS165N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS165N	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
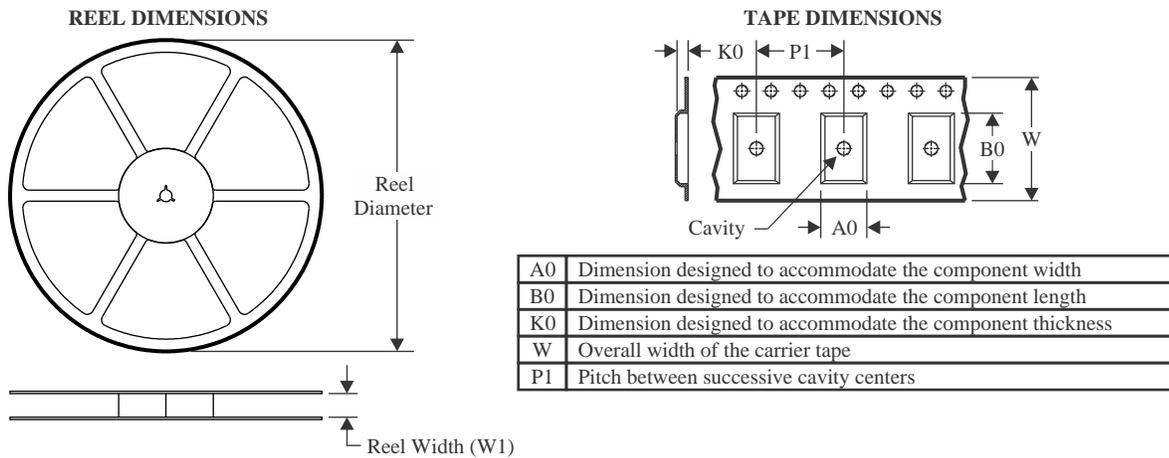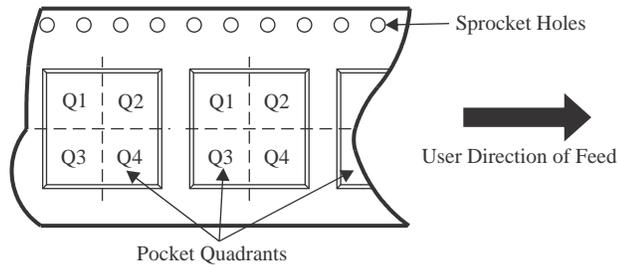
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS165DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS
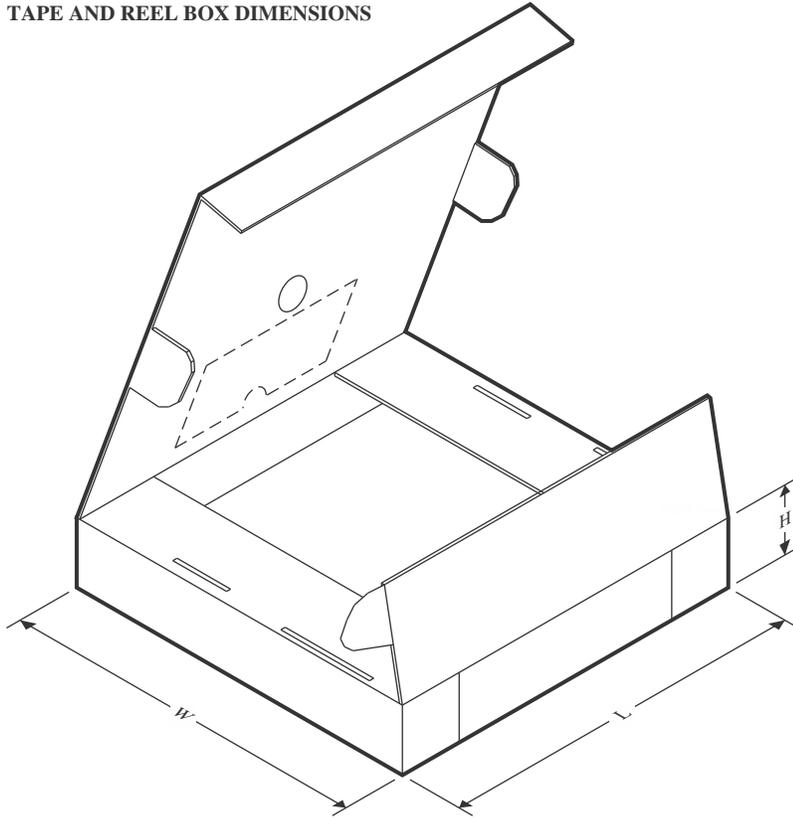
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS165DR	SOIC	D	16	2500	340.5	336.1	32.0

TUBE
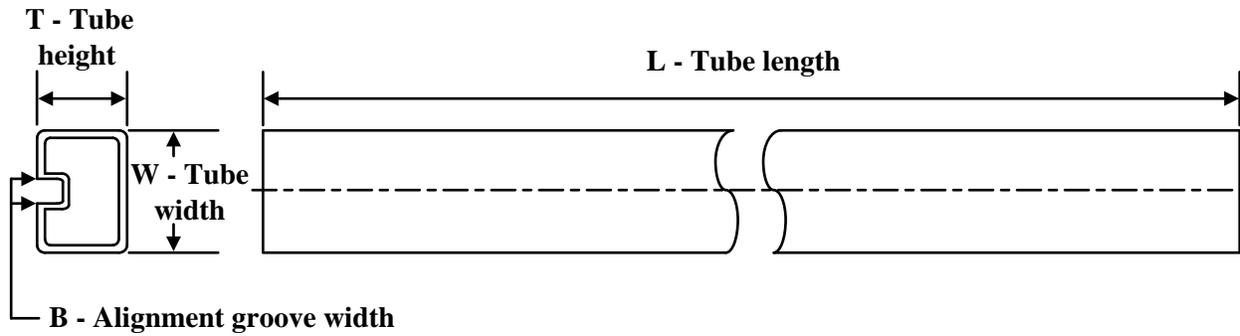
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74ALS165D	D	SOIC	16	40	507	8	3940	4.32
SN74ALS165N	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS165N	N	PDIP	16	25	506	13.97	11230	4.32

N (R−PDIP−T**)　　　　　　　　PLASTIC DUAL−IN−LINE PACKAGE

16 PINS SHOWN
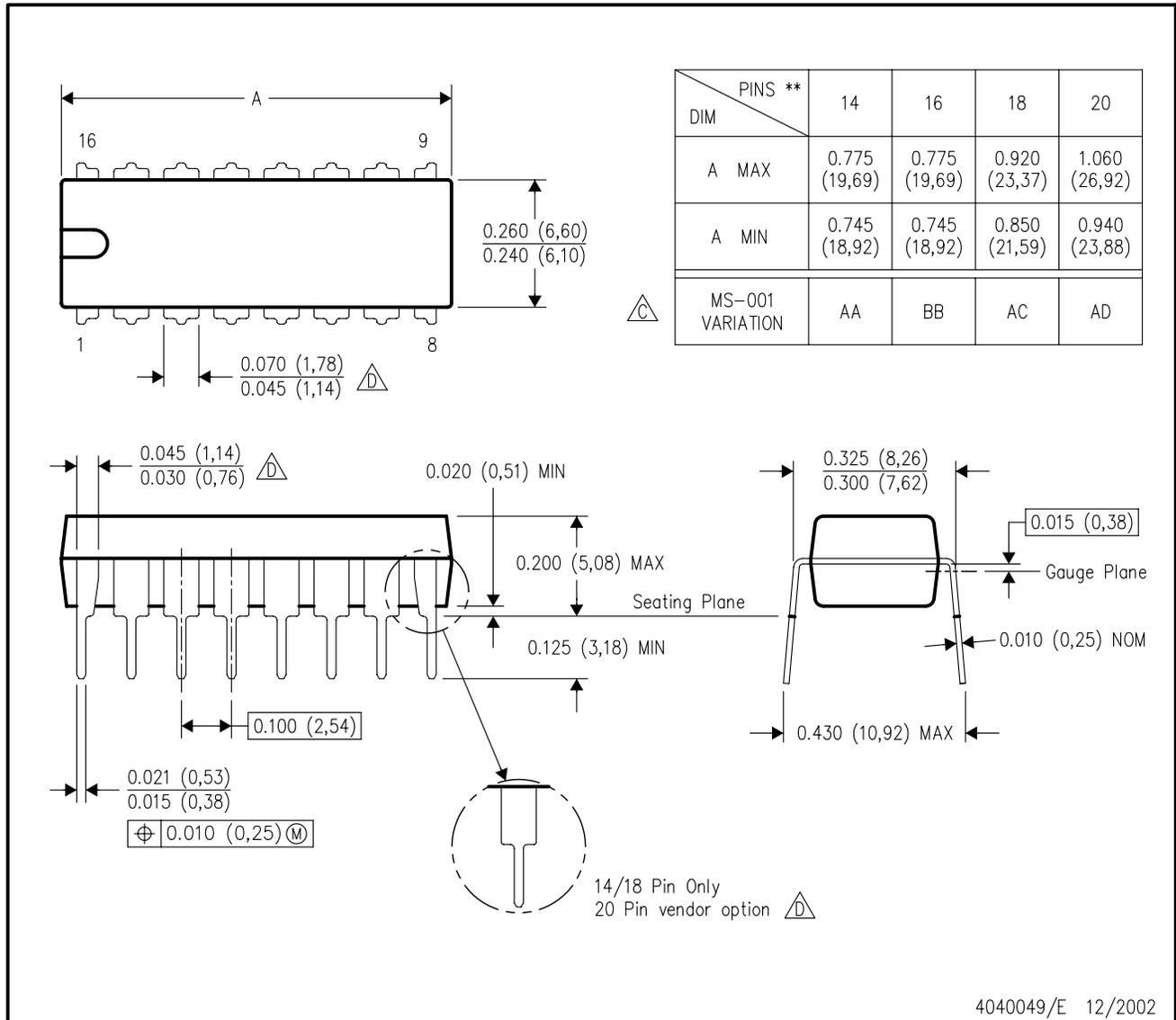
PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

0.260 (6,60)
0.240 (6,10)

0.070 (1,78)
0.045 (1,14)

0.045 (1,14)
0.030 (0,76)

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

NOTES:　A.　All linear dimensions are in inches (millimeters).
　　　　　B.　This drawing is subject to change without notice.
　　　　Ⓒ　Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
　　　　Ⓓ　The 20 pin end lead shoulder width is a vendor option, either half or full width.

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D (R−PDSO−G16)   PLASTIC SMALL OUTLINE
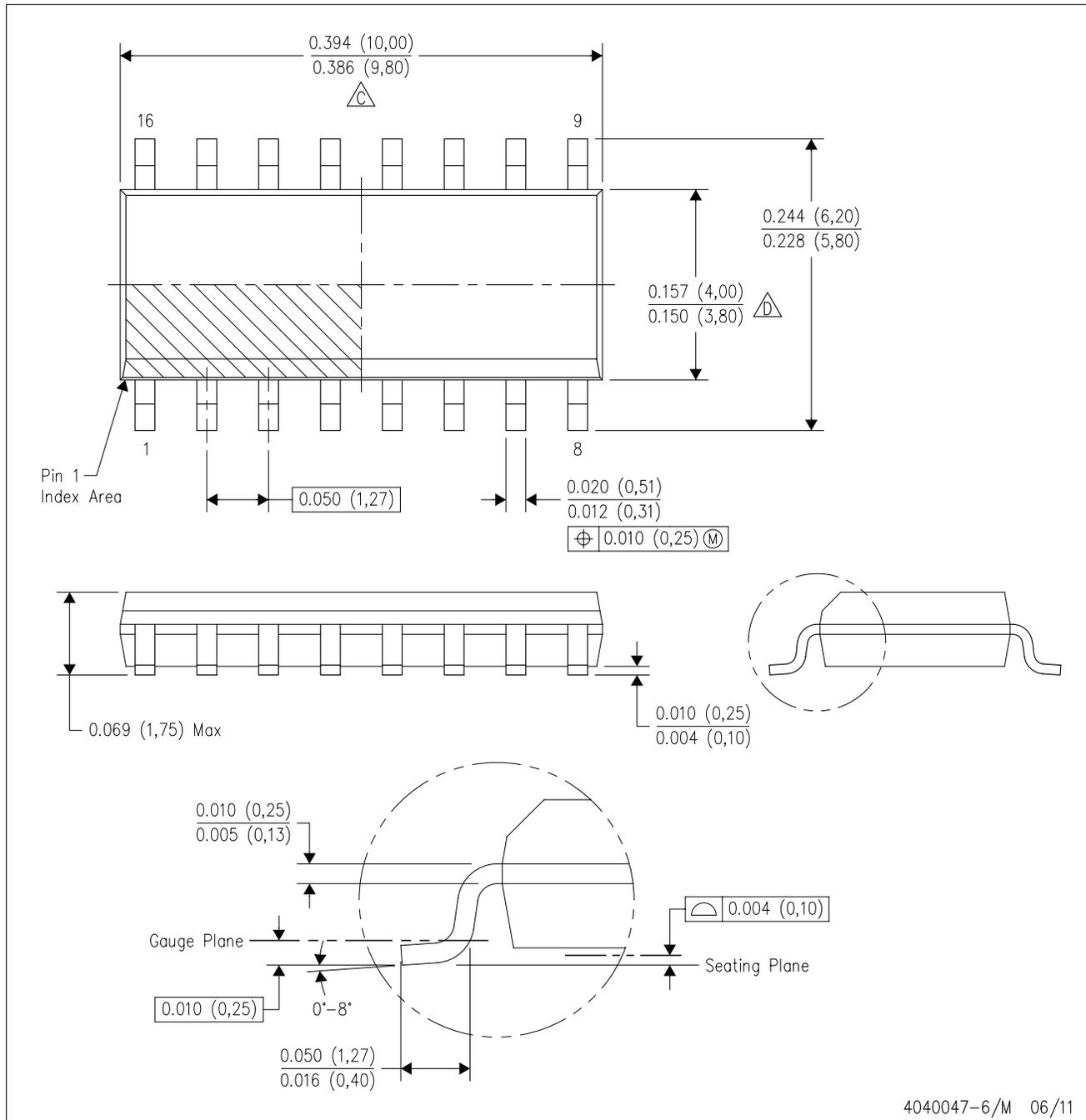
0.394 (10,00)
0.386 (9,80)
/C\

16   9

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80) /D\

1   8

Pin 1
Index Area

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ | 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.005 (0,13)

0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)

4040047−6/M   06/11

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
        /C\ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
             not exceed 0.006 (0,15) each side.
        /D\ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
         E. Reference JEDEC MS−012 variation AC.

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